

Notice of References Cited

Application/Control No.

10/071,724

Applicant(s)/Patent Under
Reexamination
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Examiner

Kimberly E Glenn

Art Unit

2817

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U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-5,750,473	05-1998	Shen, Zhi-Yuan	505/210
	B	US-4,963,844	10-1990	Konishi et al.	333/208
	C	US-6,563,403	05-2003	Kanba et al.	333/204
	D	US-6,556,109	04-2003	Kanba et al.	333/204
	E	US-5,136,268	08-1992	Fiedziuszko et al.	333/204
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Decker et al "Multichip MMIC Package for X and Ka Band" February 1997, IEEE Transactions on Component, Packaging, and Manufacturing Technology Part B, Vol 20, No.1 pages 27-33.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.